POWER INDUCTOR MOLDING TYPE
CIP SERIES

INTRODUCTION

The CIP series power inductors are surface-mount molding type which widely used in the applications such as DC/DC converters in Notebook, Netbook, desktop and server and low profile, high current power supplies.

FEATURES

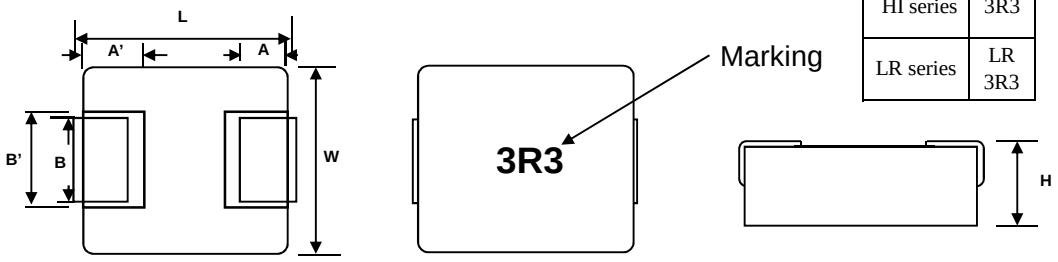
* Operating temperature -55 to +125 ^{o}C.
* High performance (saturation current) due to powdered iron composition.
* Low loss due to design of low DC resistance.
* Frequency application up to 3MHz.
* Low profile with max thickness 3.0mm.
* 100% lead free and meeted RoHS standard.
* Excellent solderability and resistance to soldering heat .
* Suitable for reflow soldering.
* High reliability and easy surface mount assembly.

PART NUMBER

CIP	0530	HI	1R0	M	-	□□
1	2	3	4	5		Internal Code

1 Product Type

2 Dimension



HI series	3R3
LR series	LR 3R3

SIZE	L (mm)	W (mm)	H (mm)	A (mm)	A' (mm)	B (mm)	B' (mm)
CIP0520	5.60 ± 0.35	5.20 ± 0.20	2.00 ± 0.10	1.0 ± 0.4	1.5 ± 0.1	2.0 ± 0.3	2.5 ± 0.2
CIP0530	5.60 ± 0.35	5.20 ± 0.20	3.00 max.	1.0 ± 0.4	1.5 ± 0.1	2.0 ± 0.3	2.5 ± 0.2
CIP0630	7.20 ± 0.30	6.65 ± 0.20	3.00 max.	1.6 ± 0.4	2.0 ± 0.1	3.0 ± 0.3	3.4 ± 0.2

3 Application

HI : High Saturation Current
LR : Low DC Resistance

4 Inductance Value

1R0 = 1.0μH 2R2 = 2.2μH
1R5 = 1.5μH 3R3 = 3.3μH

5 Tolerance

M = ± 20 %
N = ± 30 %

MOLDING TYPE INDUCTOR SPECIFICATION

1 Scope

This specification applies to fixed inductors of the following types used in electronic equipment :

LR Type	:	For low power application with lower DC resistance and lower power loss design requirement.
HI Type	:	For higher high performance application with higher saturation current requirement.

2 Construction

Configuration & Dimension	:	Please refer to the attached figures and tables.

3 Operating Temperature Range

Operating Temperature Range is the scope of ambient temperature at which the inductor can be operated continuously at rated current.

Temp. Range	:	$-55^{O}C$ to $+125^{O}C$

4 Characteristics

Standard Atmospheric Conditions

Unless otherwise specified, the standard range of atmospheric conditions for making measurements and tests are as follows :

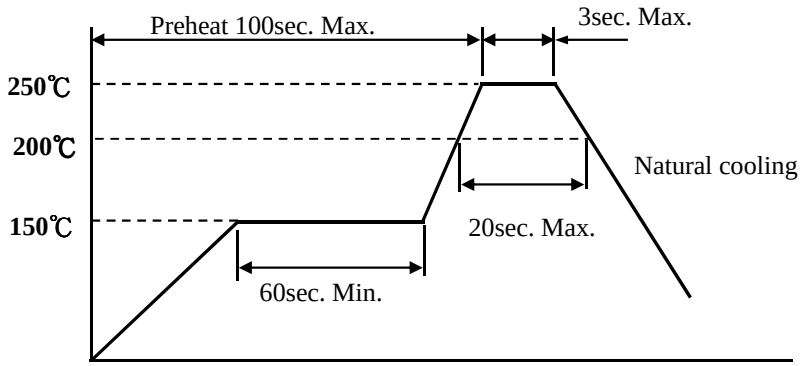
Ambient Temperature	:	25 °C ± 2 °C
Relative Humidity	:	60% to 70%
Air Pressure	:	86 Kpa to 106 Kpa

MOLDING TYPE INDUCTOR SPECIFICATION

Recommended Soldering Conditions (Please use this product by reflow soldering)

a Recommended Reflow temperature profile

(Temperature of the mounted parts surface on the printed circuit board)

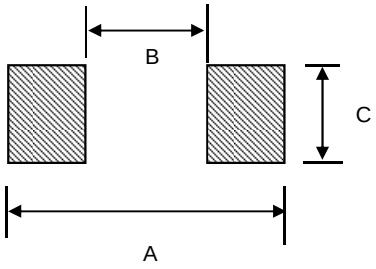


b Dip temperature

Use a solder iron of less than 30W when soldering ,do not allow the soldering iron tip directly touch the ferrite body outside of terminal electrode.

2 seconds max. at 260℃.

c Recommended Footprint



TYPE	A (mm)	B (mm)	C (mm)
0520	5.99	2.20	2.50
0530	5.99	2.20	2.50
0630	8.40	3.70	3.40

POWER INDUCTOR MOLDING TYPE

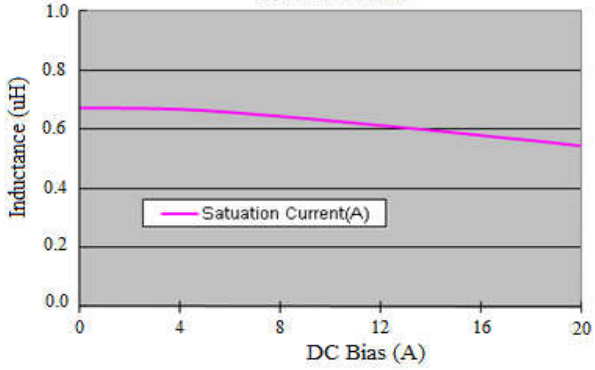
CIP0530 HI SERIES

Part No.			Inductance[1] (uH)	Percent[2] Tolerance	DCR[3] Typ.(mΩ)	DCR[3] Max.(mΩ)	Isat[4] (A)	Irat[5] (A)
CIP0530 HI	R60	□-□□	0.60	M	11.0	12.0	18.0	9.8
CIP0530 HI	R68	□-□□	0.68	M	11.0	12.0	16.0	9.5
CIP0530 HI	R82	□-□□	0.82	M	14.0	15.0	12.5	9
CIP0530 HI	1R0	□-□□	1.0	M	13.0	14.0	14.0	7
CIP0530 HI	1R2	□-□□	1.2	M	15.5	16.5	13.0	6.8
CIP0530 HI	1R5	□-□□	1.5	M	20.0	25.0	10.0	6.0
CIP0530 HI	2R2	□-□□	2.2	M	29.0	35.0	9.0	5.5

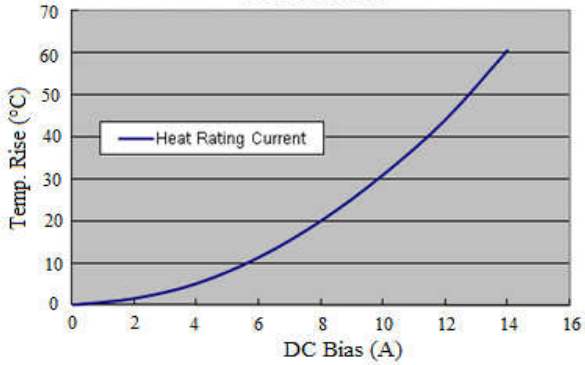
1. Inductance is measured in HP-4284A Precision LCR Meter.
2. Tolerance : M =20% , N=30% (Table shows stock tolerances in □).
3. RDC is measured in HP 4338B mill ohm meter.(or equivalent).
4. Isat : Based on inductance change (△L/Lo :-20% typical)
5. Irat : Based on temperature rise (△T : 40℃ TYP.)

CIP0530 HI SERIES

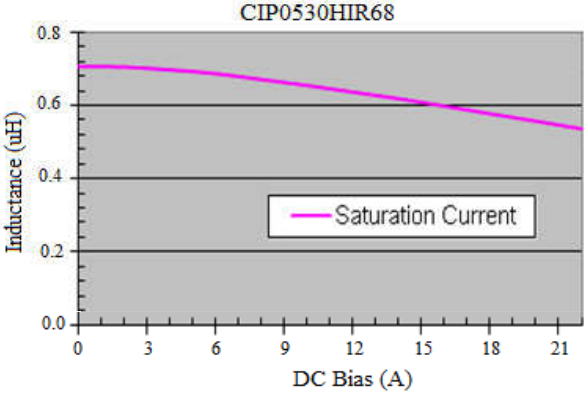
CIP0530HIR60



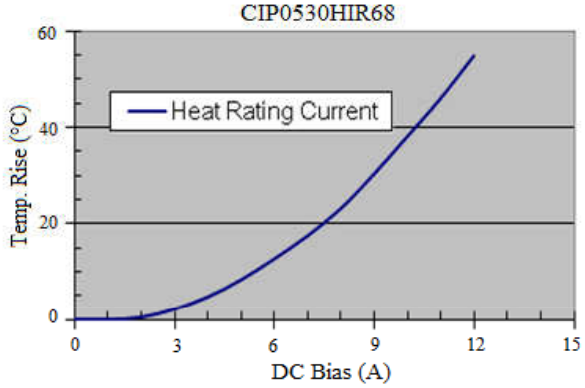
CIP0530HIR60



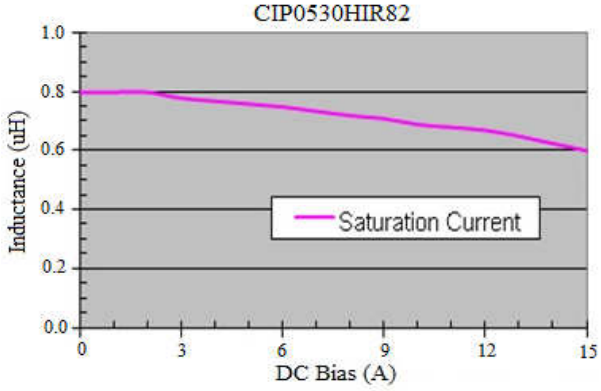
CIP0530HIR68



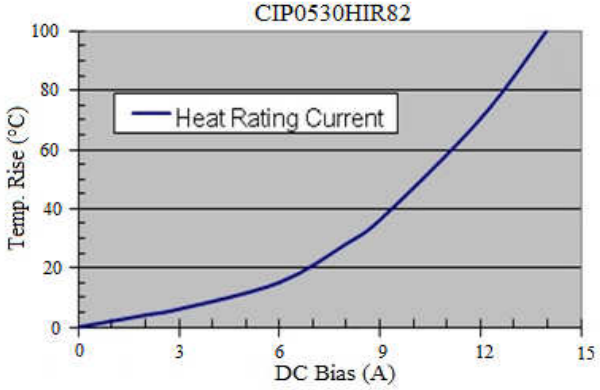
CIP0530HIR68



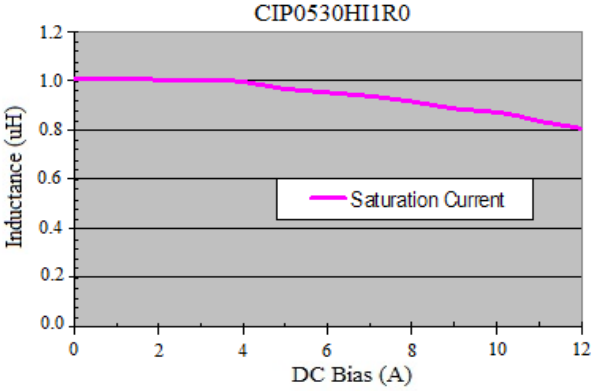
CIP0530HIR82



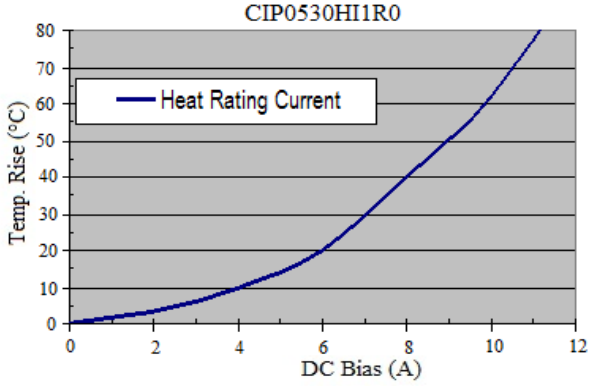
CIP0530HIR82



CIP0530HI1R0

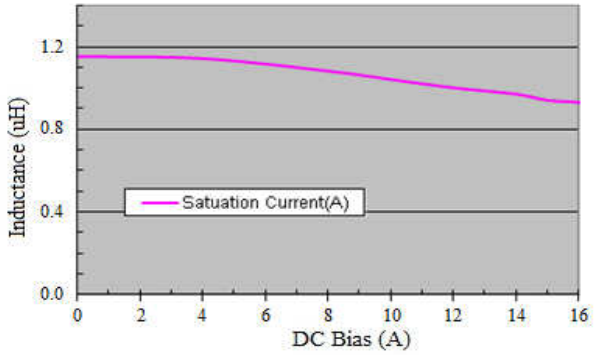


CIP0530HI1R0

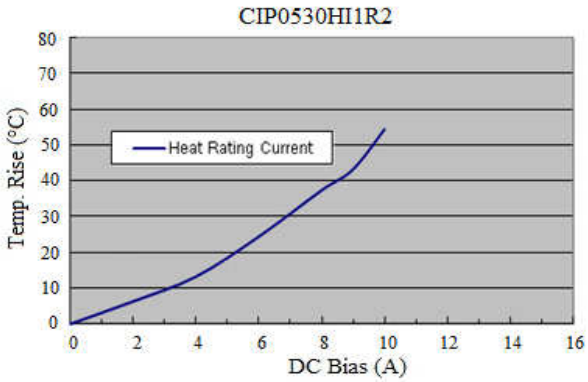


CIP0530 HI SERIES

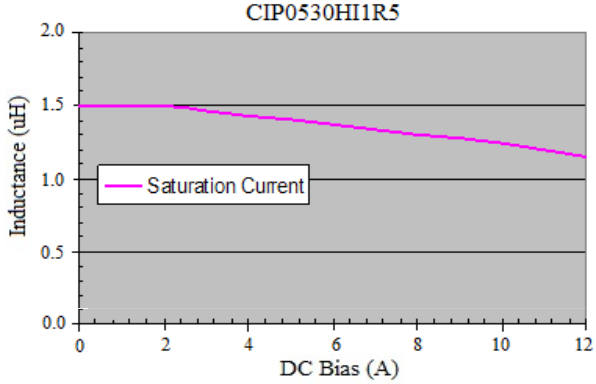
CIP0530HI1R2



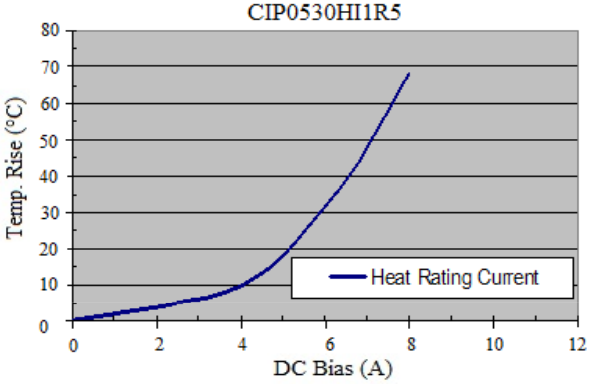
CIP0530HI1R2



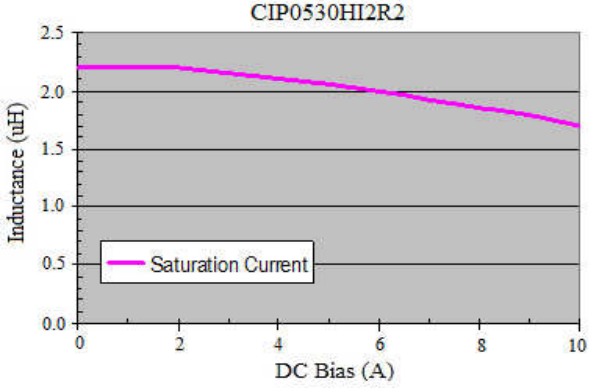
CIP0530HI1R5



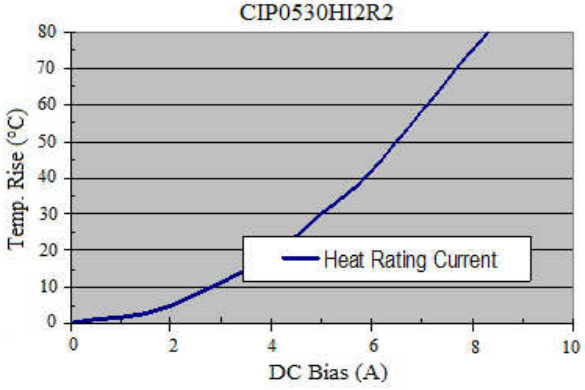
CIP0530HI1R5



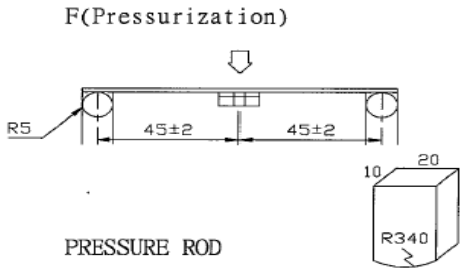
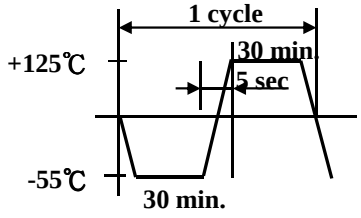
CIP0530HI2R2



CIP0530HI2R2



RELIABILITY SPECIFICATION

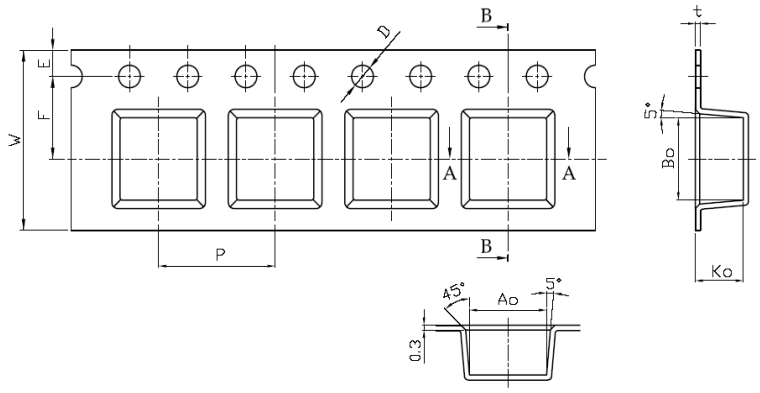
ITEM	SPECIFICATION	TEST CONDITION
Solderability	The metalized area must have 95% minimum solder coverage.	1. Preheating at 160±10℃ 90sec 2. 245°C ±5°C for 2 ±1sec
Substrate Bending	ΔL/Lo :≦±5% There shall be no mechanical damage or electrical damege.	The sample shall be soldered onto the printed circuit board and a load applied until the figure in the arrow direction is made approximately 2mm(keep time 5±1 seconds) 
Vibration	△L/Lo :≦±5% There shall be no mechanical damage	Solder specimen inductor on the test printed circuit board. Apply vibrations in each of the x,y and z directions for 2 house for a total of 6 hours. Frequency : 10~55~10Hz in 60sec as a period Amplitude : 1.5mm
High Temperature Storage	△L/Lo :≦±5% There shall be no mechanical damage or electrical damege.	The sample shall be left for 96 hours in an atmospere with a temperature of 85±2℃ and a normal humidity. Upon the measurement shall be made after the sample has been left in a normal temperature and normal humidity for 1 hour.
Low Temperature Storage	△L/Lo :≦±5% There shall be no mechanical damage or electrical damege.	The sample shall be left for 96 hours in an atmosphere with a temperature of －40±2℃. Upon completion of the test, the measurement shall be made after the sample has been left in a normal temperature and normal humidity for 1 hour.
Thermal Shock	ΔL/Lo :≦±5% There shall be no damage problems.	The sample shall be subject to 10 continuous cycles, such as shown in the following temperature cycle:  Measure the test items after leaving the inductors at room temperature and humidity for 1 hours.
Moisuture Storage	△L/Lo :≦±5% There shall be no mechanical damage.	The sample shall be left for 96 hours in a temperature of 60±2℃ and a humidity(RH) of 90～95%. Upon completion of the test, the measurement shall be made after the sample has been left in a normal temperature and normal humidity more than 1 hour.

PACKAGING INFORMATION

The packaging must be done not to receive any damage during transporting and storing.

1. Tape dimensions

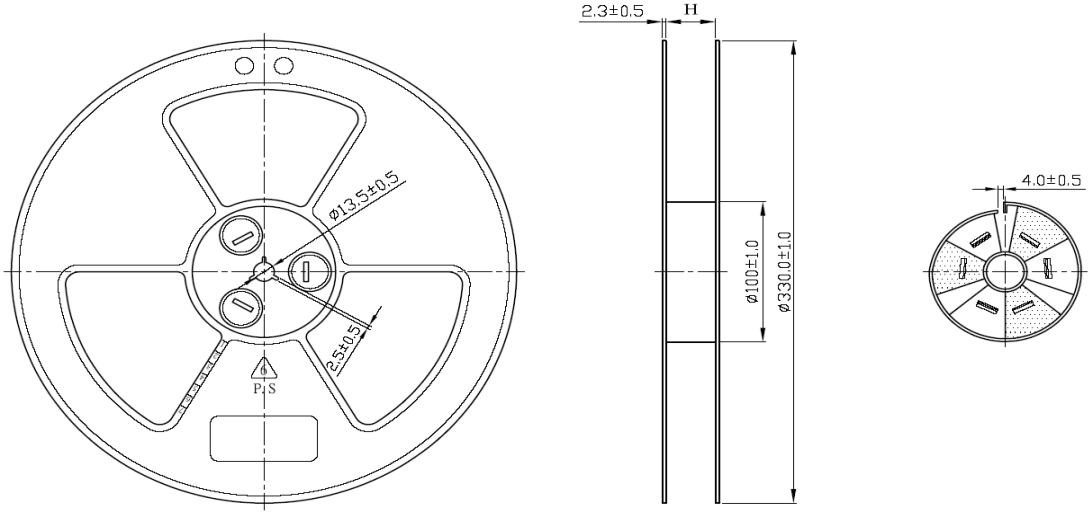
* CIP0520 / 0530 / 0630 SERIES



(Unit:m/m)

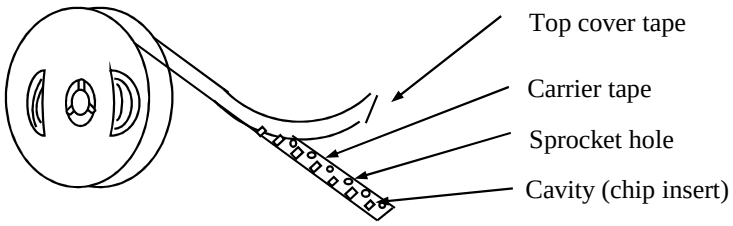
	0520	0530	0630
A0	5.30	5.30	7.20
B0	5.50	5.50	7.50
K0	2.20	3.30	3.60
P	8.00	8.00	12.00
t	0.40	0.40	0.30
W	12.00	12.00	16.00
E	1.75	1.75	1.75
F	5.50	5.50	7.50
D	1.50	1.50	1.50

2. Reel dimensions



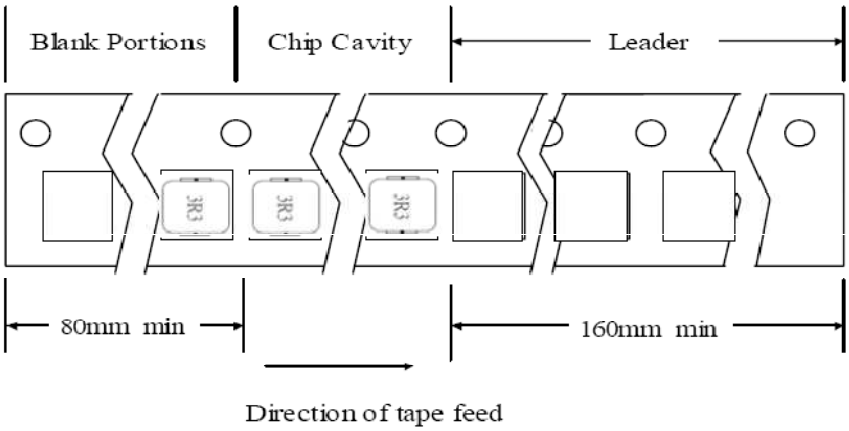
PACKAGING INFORMATION

3. Tapping figure



4. Packaging Form

There shall not continuation more than two vacancies of the product.



5. Packing Quantity

Reel Dimension (m/m) = ø330	0520 series	0530 series	0630 series
Part per Reel (pcs)	2000	2000	1500
Inner Carton	4 Reels	4 Reels	4 Reels
Master Carton (pcs)	32000	32000	24000